

# High Throughput Multidimensional Tridiagonal Systems Solvers on FPGAs

Kamalavasan Kamalakkannan, Istvan Z. Reguly, Suhaib A. Fahmy and Gihan R. Mudalige

**Abstract**—This paper presents a design space exploration for synthesizing optimized, high-throughput implementations of multiple multi-dimensional tridiagonal system solvers on FPGAs. Re-evaluating the characteristics of algorithms for the direct solution of tridiagonal systems, we develop a new tridiagonal solver library aimed at implementing high-performance computing applications on Xilinx FPGA hardware. Key new features of the library are (1) the unification of standard state-of-the-art techniques for implementing implicit numerical solvers with a number of novel high-gain optimizations such as vectorization and batching, motivated by multiple multi-dimensional systems common in real-world applications, (2) data-flow techniques that provide application specific optimizations for both 2D and 3D problems, including integration of explicit loops commonplace in real workloads, and (3) the development of a predictive analytic model to explore the design space, and obtain rapid resource and performance estimates. The new library provide an order of magnitude better performance when solving large batches of systems compared to Xilinx's current tridiagonal solver library. Two representative applications are implemented using the new solver on a Xilinx Alveo U280 FPGA, demonstrating over 85% predictive model accuracy. These are compared with a current state-of-the-art GPU library for solving multi-dimensional tridiagonal systems on an Nvidia V100 GPU, analyzing time to solution, bandwidth, and energy consumption. Results show the FPGAs achieving competitive or better runtime performance for a range of multi-dimensional mesh problems compared to the V100 GPU. Additionally, the significant energy savings offered by FPGA implementations, over 30% for the most complex application, are quantified. We discuss the algorithmic trade-offs required to obtain good performance on FPGAs, giving insights into the feasibility and profitability of FPGA implementations.

**Index Terms**—Multidimensional tridiagonal solvers, high level synthesis, field programmable gate arrays.

## 1 INTRODUCTION

TRIDIAGONAL systems of equations are solved in a wide range of High Performance Computing (HPC) applications, particularly as part of the numerical approximation of multi-dimensional partial differential equations (PDEs). In computational finance, the frequently used Alternating Direction Implicit (ADI) time discretization (see Paceman and Rachford [19], and Douglas and Gunn [10]) leads to the need to solve multiple tridiagonal systems of equations in each dimension. In computational fluid dynamics (CFD), tridiagonal systems form the core component for using implicit techniques [21] with applications in solving incompressible fluid flow problems [27] and design of turbomachinery [7], among others. The large number of independent tridiagonal systems, often in multiple dimensions, offer significant parallelization opportunities on modern multi-core and many-core architectures. Recent works such as László et al. [13] demonstrated significant speedups, re-evaluating the well known tridiagonal solver algorithms, Thomas [24], PCR [11], and their combinations.

In this paper we evaluate the parallelization opportunities afforded by tridiagonal systems solver algorithms on modern FPGA hardware devices. The data-flow parallelism

targeted in an FPGA provides significant scope to exploit the parallelism inherent in tridiagonal solvers. As such, our underlying goal is to understand the criteria for a given system solver to be amenable to FPGA implementation and uncover the limitations and profitability of such accelerators. Previous work on tridiagonal system solvers for FPGAs utilized both low-level hardware description languages [18], [28], [31] as well as high-level synthesis tools [3], [14], [15], [16], [29]. They demonstrated implementation of standard tridiagonal system solver algorithms (Thomas, PCR, and Spike), evaluating how to best utilize FPGA resources to maximize performance. However, many of these previous works only develop single system solvers in isolation without a design strategy that can be applied for multiple systems and multi-dimensions in general and do not utilize higher-gain optimizations for real-world applications. Some apply application specific optimizations which are not developed as general synthesis techniques. Comparison of performance to traditional architectures such as GPUs are also limited in current literature, minimizing insights into the utility of FPGAs for this class of applications. A key gap is the lack of a unifying design strategy particularly focusing on realistic, non-trivial applications.

In this paper we attempt to bridge this gap with a unifying workflow for designing near-optimal FPGA implementations for these implicit numerical solvers, applied to the solution of real-world multi-dimensional applications. More specifically we make the following contributions:

- We consider the standard tridiagonal solver algorithms together with state-of-the-art FPGA implementations and re-examine the algorithmic trade-offs

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required for obtaining optimized, high-throughput solutions for multiple solves in multiple dimensions. We propose a design and optimization strategy for developing FPGA implementations selecting the best designs, based on problem size, dimensionality, number of systems solved and data-flow paths required, including the utilization of High Bandwidth Memory (HBM) on modern devices for combining multiple dimension solves and explicit loops in applications. A key optimization, novel in this area is the batched execution of multiple independent solves on FPGAs leading to superior performance compared to the state-of-the-art, the current Xilinx tridiagonal solver library.

- Targeting current generation Xilinx FPGAs we implement our designs to produce a new tridiagonal solver library that can be used in the solution of multi-dimensional applications. Using this, we present the optimized design of two non-trivial applications, a 2D and 3D ADI heat diffusion solve, implemented with both single precision (FP32) and double precision (FP64) floating point representations, and a 2D Stochastic-Local Volatility (SLV) model application from the financial computing domain. Given hardware resource constraints, we focus on features of the applications that are amenable for FPGA implementation and optimizations for gaining near-optimal, high throughput performance.
- We develop a predictive analytic model that provides estimates for application runtime giving insights into the profitability of implementing the tridiagonal system solvers on Xilinx FPGAs using our design strategy. The model predicts the runtime performance considering system/batch sizes and optimizations implemented together with memory requirements and operating frequency. Runtime predictions from the model are shown to be within 15% of the achieved runtime on evaluated applications.
- Finally, the runtime, bandwidth, and energy performance of the FPGA implementations on a Xilinx Alveo U280 are compared with a state-of-the-art multi-dimensional tridiagonal solver library for GPUs on the HPC-grade Nvidia V100 GPU.

Results on the U280 FPGA demonstrate competitive performance compared to the best performance achieved for the same application on the GPU using both FP32 and FP64 representations. To our knowledge the extended workflow, new library, predictive model and the superior performance demonstrated for the above applications in this paper present key innovations, advancing the state-of-the-art. We believe our design path provides a promising strategy for use with industrial workloads, particularly from the financial computing domain, significantly reducing the complexity of the development cycle for these platforms.

The rest of the paper is organized as follows: Section 2 presents a brief overview of tridiagonal solver algorithms together with previous work on synthesizing tridiagonal solvers on FPGAs, including the current state-of-the-art. Section 3 presents our proposed design strategy, as a step-by-step methodology, starting from the basic algorithms,

down to target FPGA code for the Xilinx Alveo FPGAs. A performance analysis and benchmarking of the FPGA implementations compared to the GPU performance is presented in Section 4. Finally, conclusions are presented in Section 5.

## 2 BACKGROUND

Tridiagonal systems arise from the need to solve a system of linear equations as given in equation (1), where  $a_0 = c_{N-1} = 0$ . Its matrix form  $Ax = d$  can be stated as in equation (2).

$$a_i u_{i-1} + b_i u_i + c_i u_{i+1} = d, \quad i = 0, 1, \dots, N-1 \quad (1)$$

$$\begin{bmatrix} b_0 & c_0 & 0 & \dots & 0 \\ a_1 & b_1 & c_1 & \dots & 0 \\ 0 & a_2 & b_2 & \dots & 0 \\ \vdots & \vdots & \vdots & \ddots & \vdots \\ 0 & 0 & \dots & a_{N-1} & b_{N-1} \end{bmatrix} \begin{bmatrix} u_0 \\ u_1 \\ u_2 \\ \vdots \\ u_{N-1} \end{bmatrix} = \begin{bmatrix} d_0 \\ d_1 \\ d_2 \\ \vdots \\ d_{N-1} \end{bmatrix} \quad (2)$$

The solution to such systems of equations are well known. The Thomas algorithm [24] carries out a specialized form of Gaussian elimination providing the least computationally expensive solution, but suffers from a loop carried dependency (see Algo. 1). It has a time complexity of  $O(N)$ .

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### Algorithm 1: thomas( $a, b, c, d$ )

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- 1:  $d_0^* \leftarrow d_0/b_0$
  - 2:  $c_0^* \leftarrow c_0/b_0$
  - 3: **for**  $i = 1, 2, \dots, N-1$  **do**
  - 4:    $r \leftarrow 1/(b_i - a_i c_{i-1}^*)$
  - 5:    $d_i^* \leftarrow r(d_i - a_i d_{i-1}^*)$
  - 6:    $c_i^* \leftarrow r c_i$
  - 7: **end for**
  - 8: **for**  $i = N-2, \dots, 1, 0$  **do**
  - 9:    $d_i \leftarrow d_i^* - c_i^* d_{i+1}$
  - 10: **end for**
  - 11: **return**  $d$
- 

In contrast, the PCR algorithm [11] (Algo. 2), operates on a normalized matrix so that  $b_i = 1$  and then for each matrix row  $i$ , subtracts multiples of rows  $i \pm 2^0, 2^1, 2^2, \dots, 2^{P-1}$ , where  $P$  is the smallest integer such that  $2^P \geq N$ . This

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### Algorithm 2: pcr( $a, b, c, d$ )

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- 1: **for**  $p = 1, 2, \dots, P$  **do**
  - 2:    $s \leftarrow 2^{p-1}$
  - 3:   **for**  $i = 0, 1, \dots, N-1$  **do**
  - 4:      $r \leftarrow 1/(1 - a_i^{(p-1)} c_{i-s}^{(p-1)} - c_i^{(p-1)} a_{i+s}^{(p-1)})$
  - 5:      $a_i^{(p)} \leftarrow -r(a_i^{(p-1)} a_{i-s}^{(p-1)})$
  - 6:      $c_i^{(p)} \leftarrow -r(c_i^{(p-1)} c_{i+s}^{(p-1)})$
  - 7:      $d_i^{(p)} \leftarrow r(d_i^{(p-1)} - a_i^{(p-1)} d_{i-s}^{(p-1)} - c_i^{(p-1)} d_{i+s}^{(p-1)})$
  - 8:   **end for**
  - 9: **end for**
  - 10: **return**  $d^{(P)}$
- 

leads to each iteration reducing each of the current systems into two systems of half the size (see Fig 1). After  $P$  steps, all of the modified  $a$  and  $c$  coefficients are zero, leaving values for the unknowns  $u_i$ . In PCR, the iterations of the inner loop do not depend on each other, which is well suited for traditional multi-core/many-core architectures



performing marginally slower than the GPU (a Nvidia M4000) but providing better energy efficiency.

The Xilinx quantitative finance library [3] provides a PCR based solver, which is a templated implementation for data type, system size steps and vectorization. It must be recompiled for different configurations of the above parameters. The use of PCR means it requires more FPGA resources due to the higher computational intensity of the algorithm. The Xilinx library also implements a Douglas ADI solver [10] which to our knowledge represents a state-of-the-art application implemented with a multi-dimensional solver on a Xilinx FPGA.

In comparison to above work, the HLS-based synthesis presented in this paper, targets the solution of multiple tridiagonal systems and in multiple dimensions as commonly found in real-world applications. It uses the Thomas algorithm demonstrating that together with techniques such as batching [12] of systems, it provides higher throughput for small and medium sized systems. The Thomas algorithm requires a relatively smaller amount of DSP resources than the more computationally intensive PCR algorithm. For larger systems that do not directly fit in a single FPGA, we develop novel Thomas-Thomas and Thomas-PCR solvers to handle a number of partitioned systems and then a reduced system solve so that it can operate with the available limited on-chip memory of a single FPGA. A further innovation is the use of High Bandwidth Memory (HBM) on modern FPGAs which helps to scale the design to multiple compute units. To our knowledge, the 2D/3D ADI and SLV applications developed in this work, motivated by real-world implicit problems on FPGAs is also novel; SLV being one of the few non-trivial applications using multi-dimensional tridiagonal solvers presented in literature. The Thomas based solver developed in this paper gives higher performance than the current PCR based Xilinx library, as we will show in Section 4. The Thomas algorithm is better suited for obtaining high-throughput when solving batches of tridiagonal systems than PCR. Douglas ADI solver from Xilinx is also based on PCR. Thus, it would be similarly less performant, although implementing a different numerical method, than the ADI solvers in our work. Additionally, the predictive analytic model and the performance comparison with a state-of-the-art GPU based tridiagonal solver library gives a much needed frame of reference for evaluating our FPGA design's performance, providing insights into the feasibility and profitability of an FPGA design for realistic workloads.

### 3 FPGA DESIGN

An FPGA use a multiple-instructions, single data (MISD) architecture to implement computation, be it a single kernel or a series of kernels. There is no fixed general purpose architecture that can be exploited using software as a traditional CPU or GPU does. Instead a fixed circuit of the computation is synthesized using a variety of basic circuit elements. These are digital signal processing (DSP) blocks to implement arithmetic operators, look-up-tables (LUTs) and registers, fast on-chip block memories (BRAM/URAM), clock modules, and a rich routing fabric to connect these elements into a large logical architecture. The overall die consists of a number of these which are called Super Logic

Regions (SLR). The U280 has 3 SLRs. Bandwidth within an SLR is extremely high (TB/s) due to the wealth of connections and memory elements, while between SLRs it is limited by the number of silicon connections available. An FPGA board will also include much larger, but slower DDR4 (32 GB on the U280) memory as external memory. Managing the movement of data between these different types of memory is key to achieving high computational performance. The introduction of High-Level Synthesis (HLS) tools has reduced the complexity of FPGA programming, where a high-level programming language such as C++/OpenCL can be used with special directives to target the FPGA. However, getting good performance is still significantly challenging as code needs to be structured to suite the data-flow/pipelined programming style. The key optimizations required to obtain the best performance are transformations enabling pipelining, replication of circuit units (CUs) and tiling to improve locality such that data can be reused by fitting to fast on-chip memory. For a good overview of these techniques we refer the reader to the paper by De Matteis et al. [9] and the Xilinx HLS programming guide [2].

Considering the resources available on an FPGA, a single tridiagonal system solve, using the Thomas algorithm in Algorithm 1, would require 4 multiplications, 1 division and 2 subtractions for the forward path (lines 3-7) and one multiplication and subtraction for the backward path (lines 8-10). However, given that there are dependencies for computing  $d_i^*$  and  $c_i^*$ , each iteration of the forward path loop will have to be executed serially, incurring the full arithmetic pipeline latency,  $l_f$  ( $\approx 30$  clock cycles on a Xilinx U280 FPGA), to pass through the forward loop datapath. Additionally the backward loop can only start when all iterations of the forward path have been completed, due to the reverse data access where the loop starts from iteration  $N - 2$ . Thus the total latency for solving a single system with the Thomas algorithm would be approximately  $l_f \times N + l_b \times N$  clock cycles (assuming  $l_b$  cycles is the arithmetic pipeline latency for completing a single iteration of the backward loop). On the other hand, a PCR based single solver implementation would require 4 subtractions, 9 multiplications and 1 division within the inner loop of Algorithm 2. If  $l$  is the arithmetic pipeline latency of the inner loop, then the total number of clock cycles for the PCR algorithm, is  $(N + l) \times \log N$ . Here we assume that the outer loop is executed serially. Given the inner loop iterations are independent, they can be unrolled by some factor  $f_U = 2, 3, \dots$  which will then require  $f_U \times$  the resources to implement the inner loop. The total clock cycles will then be  $(N/f_U + l) \times \log N$ . The outer loop iterations have a dependency and thus cannot be unrolled.

For the Thomas solver, there are  $l_f$  clock cycles between consecutive iterations of a single system solve in the forward path. This can be considered as a *dependency distance*. As such, we could attempt to solve  $l_f$  number of tridiagonal systems to fully utilize the forward path circuit pipeline. This can be done by *interleaving* the iterations of the forward pass loop of the Thomas solver such that iteration 1 of system 1 is input followed by iteration 1 of system 2 and so on, per clock cycle, up to iteration 1 of system  $l_f$ . In fact selecting a group,  $g = \text{MAX}(l_f, l_b)$  enables  $g$  system solves to be interleaved, saturating the pipeline. If there are

$B$  number of total tridiagonal systems to be solved, i.e. a batch size of  $B$ , then the total latency with Thomas can be shown to incur a latency given by (4):

$$(1 + \lceil B/g \rceil) \times gN \quad (4)$$

Thus for large  $B$  the total latency tends to be  $BN$ . This is a characteristic of all  $O(N)$  algorithms, which ideally can be pipelined to take input each clock cycle at the cost of differing resource consumption.

For the PCR algorithm, given there are no dependencies between iterations of a single system, solving a batch of  $B$  systems (by batching the inner loop) incurs the latency in (5):

$$(BN/f_U + l) \times \log N \quad (5)$$

For large  $B$ , dividing (5) by (4) gives a factor of  $\log N/f_U$  pointing to the fact that the batched Thomas solver is  $\log N$  times faster than batched PCR, for  $f_U = 1$ . Thus, to match the Thomas solver latency, a batched PCR implementation needs an unroll factor  $f_U = \log N$ . However, given that the PCR inner loop has a considerably larger resource requirement, compared to the Thomas solver, on a given FPGA with fixed amount of resources, the batched Thomas solver will always provide better performance. The exception occurs when the system size,  $N$  is large and FPGA on-chip memory becomes the limiting factor. We discuss the design and best algorithms for such cases in Sec 3.1.

Considering a batched solver based on the spike algorithm, assume each system in the batch is of size  $N$ . The algorithm creates  $m$  number of blocks and each has LU and UL factorization done in parallel, followed by the pentadiagonal solve and then back-substitution in parallel. This incurs a total latency given by (6) :

$$(1 + \lceil Bm/g + 1 \rceil) \times gN/m + mC \quad (6)$$

The latency for the factorization for each block (first term), is similar to a Thomas forward and backward solve carried out in an interleaved manner. Although the number of cycles spent on the pentadiagonal reduced system solve is  $BmC$  (assuming a linear latency model) and back substitution is  $BN$ , only the latency for first stage of pentagonal solver is added to equation 6 as all three modules are pipelined. Back substitution does not add additional delay between its inputs and outputs. When  $B$  is sufficiently large and stages are pipelined, a latency of  $BN$  is achieved. Again this is due to the spike algorithm having a  $O(N)$  complexity. However, if  $BmC \geq BN$  then data flow must stall for some time decreasing throughput. Considering resource consumption the LU/UL factorization requires  $3\times$  the resources for an equivalent Thomas solver and the pentadiagonal solver requires additional resources (again more than an equivalent Thomas solver).

Given the lower resource requirements and profitability of the Thomas algorithm, compared to the other algorithms, we first focus on its optimized batched implementation on an FPGA for system sizes that can fit into on-chip memory. As we are interleaving groups of  $g$ , the  $a_{i-1}$ ,  $b_{i-1}$  and  $c_{i-1}$  values needs to be stored in on-chip memory such that they can be used in subsequent ( $i$ th) iterations. For a FP32 implementation we have found that a grouping of 32 is sufficient to effectively pipeline the computation (this is 64 for FP64) on the Xilinx Alveo U280. The forward and

backward loops operate in opposite directions and thus a First-In-First-Out (FIFO) buffer cannot be used, rather on-chip addressable memory is used for data movement. The forward and backward loops can be made to operate in parallel when batching a number of system solves, using ping-pong buffers (also called double buffers). With this technique, dual port memory is partitioned into two parts, one for the writing process the other for the reading. Once writes (by the forward pass) and reads (backward pass) are completed, read and write locations are swapped. Note that the very first read has to wait till the very first write has completed. Additionally, the technique also doubles the memory requirement compared to using the same memory portion for both read and write. Including the latency for starting the first write to the ping-pong buffer, and writing back the final result to external memory increases the total latency in (4) by  $2gN$  to give:  $(3 + \lceil B/g \rceil) \times gN$  clock cycles. The total on-chip memory required for a single Thomas solver interleaving  $g$  systems can be computed based on the need to store the  $a, c, d, c^*, d^*$  and  $u$  vectors, where each consumes  $2gN$  words in the ping-pong buffers. The total  $12gN$  requirement with dual port memory can be satisfied with  $6\times$  dual port block RAMs (URAM/BRAM) each with a capacity of  $2gN$ . Additionally there is a need to store  $g$  values of the  $i - 1$ th iteration separately, requiring 4 RAMs with a capacity of  $g$  words.

Data transfer from external memory to on-chip memory plays a crucial part in achieving high performance, especially for multi-dimensional solvers such as the 3D ADI heat diffusion application detailed later in this paper. If we consider a 3D application with systems sizes ( $N$ ) of 256 in all three dimensions, then a solve along the x-dimension will have YZ ( $256 \times 256$  in this case) number of systems to be solved, each corresponding to an  $x$ -line system of size 256. Given the data is stored in consecutive memory locations along the x-lines, good memory throughput can be achieved. However to exploit the full memory bandwidth, a larger number of memory ports needs to be used. For the 512-bit memory ports, on the Alveo U280, it is sufficient to saturate the data-flow pipeline with a width of 256-bits at a 300MHz clock speed, which is our target frequency. This enables us to fetch data sufficient to feed 8 Thomas solvers in parallel. Such a configuration can be viewed as a *vectorized* Thomas solver. Additionally, the total YZ number of x-lines can be set up to be solved in groups ( $g$ ) of 32. Here, the 1st Thomas solver circuitry solves the 0th, 8th, 16th and so on x-lines, the 2nd solves 1st, 9th, 17th and so on x-lines, and so on. Batches of x-lines can be solved in such interleaved groups to saturate the data flow pipeline to achieve higher throughput.

In the x-dimension, the reads from external memory bring in data stored in consecutive memory locations. However, the data fetched belongs to the same line (i.e. same system), thus we need to buffer 8 x-lines internally and carry out an  $8 \times 8$  transpose to feed that to 8 different solvers (see Fig. 2a for an illustration of the issue with a  $4 \times 4$  transpose). For solving along the y-dimension, we fetch each XY plane to on-chip memory to avoid strided memory accesses and then read along the y-lines from the on-chip memory (see Fig. 2b). Similarly for solving along the z-dimension, we read in x-lines (which are consecutive



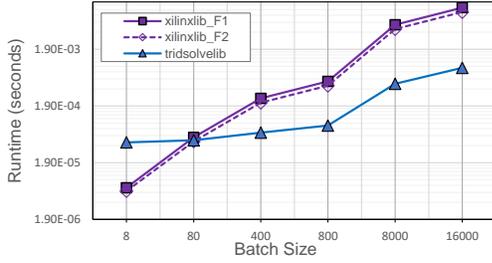


Fig. 4: tridsolvlib vs xilinxlib, System size-128

$$(2 + \lceil Bt/g \rceil) \times \lceil N/t \rceil g + (2t + l) \times \log(2t) \quad (9)$$

Again for larger  $B$ , this tends to  $Bt\lceil N/t \rceil$ , however, there is a lower on-chip memory requirement of  $(2t + l) \times \log(2t)$  words for each of 3 FIFO buffer, due to the lower latency for reduced system solve in PCR. Since data flow design requires matching performance of solving tiles and the reduced system and as PCR is faster when solving reduced systems, the number of tiles can be increased even for smaller systems, further reducing requirement for on chip memory for the first phase of the algorithm. As such we can conclude that the Thomas-PCR version would result in better performance.

#### 4 PERFORMANCE

In this section we present performance from our FPGA design strategy for high-throughput tridiagonal system solvers. First, we briefly compare the performance of our library to a current state-of-the-art FPGA tridiagonal solver library from Xilinx [3] which is based on PCR, demonstrating the higher performance gains from a batched Thomas-based solver as predicted by the analytic model developed in Section 3. Batching of systems is key to higher performance. Fig. 4 presents performance of 1D tridiagonal systems of size 128, solved using the Xilinx library (xilinxlib-F1) compared to our Thomas algorithm-based implementation (tridsolvlib) on a range of batch sizes. As discussed in the analytic model, for larger batch sizes the Xilinx library performed significantly slower than the Thomas based solver. Adding further optimizations, such as inner loop unrolling and a FIFO data path to the Xilinx solver (xilinxlib-F2) only marginally improved performance, leaving an order of a magnitude performance gap. We also observed that the PCR-based xilinxlib-F2 implementation consumed higher resources (an example is given in Table 1 for the batch size of 8000 systems).

In the remainder of this section we focus on using our FPGA design strategy. Specifically, we apply it to two representative, non-trivial applications. We investigate both 2D and 3D applications, with both FP32 and FP64 representations. Model predicted resource utilization estimates are used to determine initial design parameters and model predicted runtimes, which we compare to actual runtimes of the applications on a Xilinx Alveo U280. We use Vivado C++ due to ease of use for configurations and support of some C++ constructs compared to OpenCL. However, we note that OpenCL could equally be used to implement the same design. Finally, we compare performance on the FPGA to an NVIDIA Tesla V100 GPU using the tridiagonal solver library, tridsolver implemented by László et al. [13] [1] using its batched version presented by Reguly et al. [22]. This GPU library

TABLE 1: Xilinx library performance : 8000 systems of size 128

Design	Runtime (ms)	BW (GB/s)	DSP	URAM	BRAM
tridsolvlib	0.47	43.34	218	76	50
xilinxlib-F1	5.15	3.97	447	20	70
xilinxlib-F2	4.32	4.73	655	20	102

TABLE 2: Experimental systems specifications.

FPGA	Xilinx Alveo U280 [30]
DSP blocks	8490
BRAM / URAM	6.6MB (1487 blocks) / 34.5MB (960 blocks)
HBM	8GB, 460GB/s, 32 channels
DDR4	32GB, 38.4GB/s, in 2 banks
Host	AMD Ryzen Threadripper PRO 3975WX (32 cores) 512GB RAM, Ubuntu 18.04.6 LTS
Design SW	Vivado HLS, Vitis 2019.2
GPU	Nvidia Tesla V100 PCIe [17]
Global Mem.	16GB HBM2, 900GB/s
Host	Intel Xeon Gold 6252 @2.10GHz (48 cores) 256GB RAM, Ubuntu 18.04.3 LTS
Compilers, OS	nvcc CUDA 10.0.130, Debian 9.11

has been shown [6] to provide matching or better performance than the two current batch tridiagonal solver functions – `cusparse<t>gtsv2StridedBatch()` and `cusparse<t>gtsvInterleacedBatch()`, in Nvidia’s cuSPARSE library [4], [25]. Our experimnts also confirmed these results for the applications evaluated in this paper. Additionally it features direct support for creating multi-dimensional solvers, whereas cuSPARSE requires data layout transformations, for example in between doing an x-solve and a y-solve to implement multi-dimensional problems. Thus we use `tridsolver` in our evaluation throughout this paper, but note that cuSPARSE libs would have equally provided the same insights when compared to the FPGA solvers on the U280. Given that previous work has demonstrated GPUs to provide significantly better performance than multi-threaded CPUs [13], we do not compare with CPU runs. Table 2 briefly details the specifications of the FPGA and the GPU systems (both hardware and software) used in our evaluation. The V100 is based on 12nm gate size comparable to the U280’s 16nm gate size. It has a peak bandwidth of 900GB/s, nearly twice that of the U280’s 460GB/s bandwidth.

#### 4.1 ADI Heat Diffusion Application

The first application is an ADI based solve of the heat diffusion equation. The high-level algorithm of the application in 3D is detailed in Algo. 3. The application consists of an iterative loop which starts by calculating the RHS values using a 7-point stencil, followed by calls to the tridiagonal solver for each of two or three dimensions, depending on whether the application is 2D or 3D respectively. The updates from the tridiagonal solver, `Tridslvs` is accumulated to  $u$  before the next iteration. For the 3D ADI application, there are three calls to `Tridslv`. An initial design implements it as a single hardware unit given the data dependencies between the calls. This enables FPGA resource utilization to be maximized by implementing 6 CUs each having 8 Thomas solvers synthesized as a vectorized solver. The RHS calculation, which is a 3D explicit stencil loop, was implemented following techniques in Kamalakkannan et al. [12], as a separate module. The intermediate results between CUs and RHS module were written/read to/from

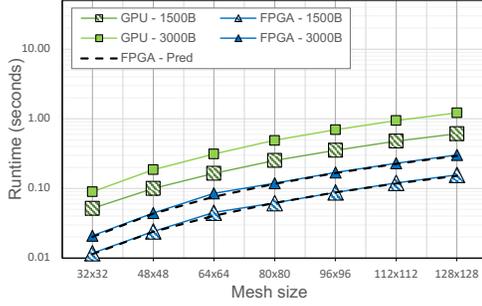
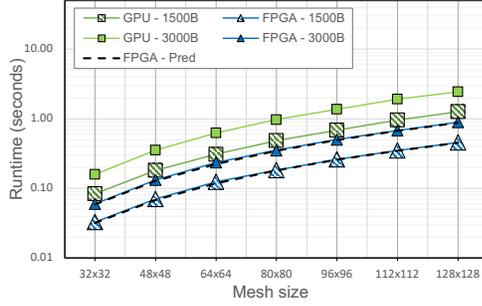
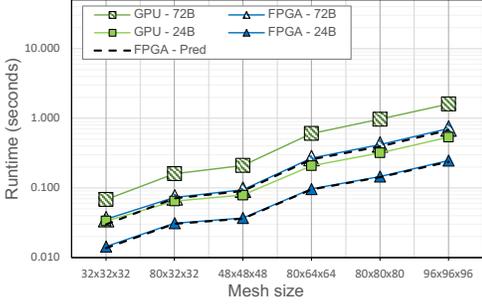
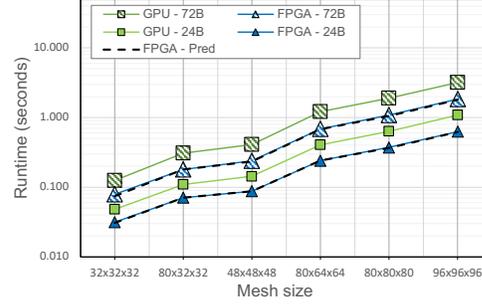
(a) 2D FP32 - 120 iter.  $v = 8, f_U = 3, N_{CU} = 3$ (b) 2D FP64 - 120 iter.  $v = 8, f_U = 2, N_{CU} = 3$ (c) 3D FP32 - 100 iter.  $v = 8, N_{CU} = 6$ (d) 3D FP64 - 100 iter.  $v = 8, N_{CU} = 3$ 

Fig. 5: ADI Heat Diffusion Application Performance

**Algorithm 3:** 3D ADI Heat Application

- 
- 1: **for**  $i = 0, i < n_{iter}, i + +$  **do**
  - 2: Calculate RHS :  
 $d = f_{Tpt}(u), a = \frac{-1}{2}\gamma, b = \gamma, c = \frac{-1}{2}\gamma$
  - 3: Tridslv(x-dim), update  $d$
  - 4: Tridslv(y-dim), update  $d$
  - 5: Tridslv(z-dim), update  $d$
  - 6:  $u = u + d$
  - 7: **end for**
- 

external memory. The number of CUs is then limited by the available HBM ports but not by any other resource. An improvement on this initial design fuses the generation of  $a, b, c$  coefficients with the tridiagonal solver. This enables the required number of HBM ports to be reduced and implementation of a maximum of 16 CUs. We opt for 12 CUs to reduce routing congestion which affects the maximum frequency achievable on the FPGA.

The x-dim and y-dim solves can be synthesized as separate modules, pipelining the X and Y dimension calculation without needing to buffer intermediate results in external memory. Essentially, XY planes are buffered in on-chip memory to implement this, but it limits the mesh sizes solvable given the increased BRAM/URAM usage. To also pipeline the z-dim solve the full mesh must be buffered on-chip which significantly limits the mesh size, hence we do not attempt it here. The pipelining reduces the bandwidth requirement by half compared to the previous design. First module, RHS+Tridslv(x-dim)+Tridslv(y-dim) and second module Tridslv(z-dim) operate in parallel in a ping-pong fashion. This effectively increases the number of modules working in parallel to 24, considering the availability of HBM ports. The design now has a large pipeline start delay and is best utilized by batching large

numbers of 3D meshes to obtain higher throughput. Xilinx data flow design synthesis requires separate data structures for independent read and write operations. We introduce two data structures for accumulation in line 6 of Algo 3. But due to limited HBM ports, we had to share single HBM ports with two data structures. This limits the data flow per data structure from/to the HBM2 ports as well as size of data structure, given single HBM port's capacity is 256MBs. This final design gave the best performance in our evaluations. The full pipeline latency for the design can be shown to be given by (10):

$$L_{adi,3D} = n_{iter} \times MAX(L_{rhs+xy}, L_z) \quad (10)$$

$$L_{rhs+xy} = \left(\frac{2xy}{v}\right) + \left(2v\frac{x}{v} + 3gx\right) + \left(\frac{2xy}{v} + 3gy\right) + \left\lceil \frac{B}{2N_{CU}} \right\rceil \left(\frac{xyz}{v}\right) \quad (11)$$

$$L_z = \left(\frac{2xz}{v} + 3gz\right) + \left\lceil \frac{B}{2N_{CU}} \right\rceil \left(\frac{xyz}{v}\right) \quad (12)$$

Here,  $x, y$  and  $z$  are the size of systems in each dimension,  $N_{CU}$  is the number of CUs implemented on the FPGA and  $B$  is the total number of 3D meshes, i.e the number of batches. The first term in (11) accounts for the latency of the 3D stencil computation in RHS which operates over 3 planes. Here we read  $xy$  number of mesh points in groups of the vectorization factor  $v$ . The second term is for Tridslv(x-dim) including latency to transpose the x-lines when reading/writing. Similarly the third term is for Tridslv(y-dim) including the read/write y-lines from the buffered x-lines. The final term is the latency to process  $B$  number of meshes using  $N_{CU}$  number of CUs. In (12) the first term is for the read/write and solving in the z dimension with Tridslv(z-dim). We take the maximum in (10) because the two modules need to be synchronized, as they are going to swap their read and write location after processing  $B/2$  meshes. The vectorization factor  $v$  is 8 for our design and  $g$  is 32 for FP32 and 64 for FP64. A minor

TABLE 3: ADI Heat Diffusion Application: Achieved Bandwidth,  $BW$  (GB/s) and Energy,  $E$  (J)

2D FP32 (120 iterations, $f_U = 3$ ), F - FPGA, G - GPU												
Mesh	BW-1500B			E-1500B		BW-3000B			E-3000B		G	
	F	Gx	Gy	F	G	F	Gx	Gy	F	G		
32 <sup>2</sup>	501	134	418	1	7	563	164	493	2	13		
48 <sup>2</sup>	551	168	472	2	14	596	187	507	3	26		
64 <sup>2</sup>	524	184	528	3	23	556	199	553	6	42		
80 <sup>2</sup>	597	191	523	5	39	621	202	533	9	72		
96 <sup>2</sup>	604	201	541	7	51	627	207	543	13	99		
112 <sup>2</sup>	602	203	539	9	71	626	208	535	17	138		
128 <sup>2</sup>	602	207	563	12	86	620	206	565	23	168		
2D FP64 (120 iterations, $f_U = 2$ ), F - FPGA, G - GPU												
Mesh	BW-1500B			E-1500B		BW-3000B			E-3000B		G	
	F	Gx	Gy	F	G	F	Gx	Gy	F	G		
32 <sup>2</sup>	360	184	508	2	10	395	196	543	4	21		
48 <sup>2</sup>	377	199	527	5	24	402	206	536	10	51		
64 <sup>2</sup>	380	203	557	9	42	399	203	529	18	88		
80 <sup>2</sup>	402	209	550	14	68	418	209	542	26	142		
96 <sup>2</sup>	408	209	557	20	98	421	211	563	38	199		
112 <sup>2</sup>	411	208	543	26	139	424	209	549	51	277		
128 <sup>2</sup>	411	204	517	34	179	422	210	551	67	355		
3D FP32 (100 iterations), F - FPGA, G - GPU												
Mesh	BW-24B				E-24B		BW-72B				E-72B	
	F	Gx	Gy	Gz	F	G	F	Gx	Gy	Gz	F	G
32 × 32 × 32	218	119	218	288	1	4	266	172	384	493	3	9
80 × 32 × 32	252	136	364	474	2	8	323	188	411	539	5	23
48 × 48 × 48	288	171	355	475	3	11	338	198	399	551	7	31
80 × 64 × 64	326	194	412	548	7	31	351	207	438	561	27	70
80 × 80 × 80	337	201	417	556	11	48	353	203	394	543	31	150
96 × 96 × 96	346	210	429	568	18	78	358	211	425	563	53	241
3D FP64 (100 iterations), F - FPGA, G - GPU												
Mesh	BW-24B				E-24B		BW-72B				E-72B	
	F	Gx	Gy	Gz	F	G	F	Gx	Gy	Gz	F	G
32 × 32 × 32	201	165	358	445	2	6	239	193	420	527	6	17
80 × 32 × 32	222	182	406	531	5	15	262	204	419	548	14	44
48 × 48 × 48	242	194	401	536	7	20	267	207	420	554	18	59
80 × 64 × 64	262	205	427	561	18	20	274	209	426	563	52	173
80 × 80 × 80	265	209	431	564	28	90	271	209	423	563	82	275
96 × 96 × 96	271	205	426	550	47	155	276	211	442	565	139	464

consideration for obtaining improved predictions from the above model is when the number of points per clock cycle arriving to the vectorized solvers is different to  $v$  due to memory bandwidth. For example if we share a single HBM port to read two data structures and if we use 256 bit data path a lower number of points  $p$  will come through the data path than  $v$ . Then, replacing  $v$  by  $p$  will be more accurate.

A similar design can be developed for the 2D ADI application, but now the functions in the iterative loop  $\text{RHS}$ ,  $\text{Tridslv}(x\text{-dim})$  and  $\text{Tridslv}(y\text{-dim})$  can all be pipelined. This makes it possible to unroll the iterative loop by some factor  $f_U$ . Note that the variable  $u$  is incremented each iteration (line 6 of Algo. 3) where the previous value of  $u$  needs to be input at the end of each unrolled iteration to carry out this increment. However  $\text{RHS}$  of each iteration also consume  $u$  and thus we use a delay-buffer (similar to ones used in StencilFlow [8]) implemented as an HBM FIFO to feed the previous values of  $u$  to the increment stage noted in line 6. Unrolling iterative loop reduced the total number of data structures in external memory. Hence we are able to assign dedicated ports for each data structure which enable better data flow throughput. The performance model for the

2D application is given in (13).

$$L_{adi,2D} = (n_{iter}/f_U) \times L_{rhs+xy} \quad (13)$$

$$L_{rhs+xy} = f_U \times \left[ \left( \frac{2x}{v} \right) + \left( 2v \frac{x}{v} + 3gx \right) + \left( \frac{2xy}{v} + 3gy \right) \right] + \left[ \frac{B}{N_{CU}} \right] \frac{xy}{v} \quad (14)$$

Pipeline latency increases with the unroll factor  $f_U$ , but for large  $B$  it results in a higher overall speedup. The size of the FIFO delay buffer is equivalent to the total delay of  $\text{RHS}$ ,  $\text{Tridslv}(x\text{-dim})$  and  $\text{Tridslv}(y\text{-dim}) : 2x/v + 2vx/v + 3gx + 3gy + 2xy/v$ .

Fig. 5 details the performance of the 2D ADI Heat diffusion application implemented in both FP32 (a) and FP64 (b) on the Alveo U280 and compares it to execution on the V100 GPU. The design parameters for each are noted in the graphs. Operating frequencies are 292MHz and 288MHz for FP32 and FP64 respectively. In both cases the coefficients  $a, b$  and  $c$  are internally generated, on the FPGA. This means that only  $u$  is read. Performance results demonstrate the FPGA outperforming the GPU particularly for runs with large batch sizes. Additionally the predictive model accuracy is over 85% with large batched predictions being more accurate at over 90%. Inspecting the effective bandwidth on each device as detailed in the top two sub-tables in TABLE 3 provides insights into the superior performance of the FPGA. The bandwidth is computed by counting the total number of bytes transferred during the execution of each call in Alg. 3, looking at the mesh data accessed and dividing it by the total time taken by each call. On the GPU, we have detailed the achieved bandwidth of the  $x$ - (Gx) and  $y$ -dim (Gy) solves. On the FPGA we show the full bandwidth achieved in the pipeline. The  $x$ -dim bandwidth on the GPU is significantly worse due to the  $8 \times 8$  transpose operations. Such lower bandwidths are also confirmed by László et al. [13]. We additionally confirmed the same performance when using `cuSPARSE's cusparse<t>gtsv2StridedBatch()` library function for the  $x$ -solve. The higher performance of the FPGA can be attributed to the unrolling of the iterative loop allowing higher bandwidth utilization for the data path and the internal generation of coefficients. The GPU tridiagonal solver library is not currently setup for such an optimization. Thus, the application writes  $a, b, c$  and  $u$  to global memory after  $\text{RHS}$  and intermediate results also written/read between the two  $\text{Tridslv}$  calls whereas on the FPGA these stay on-chip. Even with modifications to the GPU library to generate coefficients internally which would improve GPU performance, we believe the FPGA results point to a very competitive solution, particularly when batching large meshes that can fit within the resource constraints of the FPGA implementation, for this application.

The first two sub-tables in TABLE 3 also detail the energy consumption of the 2D runs. The `xbutil` utility was used to measure power during FPGA execution, while `nvidia-smi` was used for the same on the V100. The FPGA on average consumed 75W while the GPU power draw ranged from 50W to 250W. Results indicate that the FPGA energy consumption is approximately  $5\times$  to  $6\times$  lower for

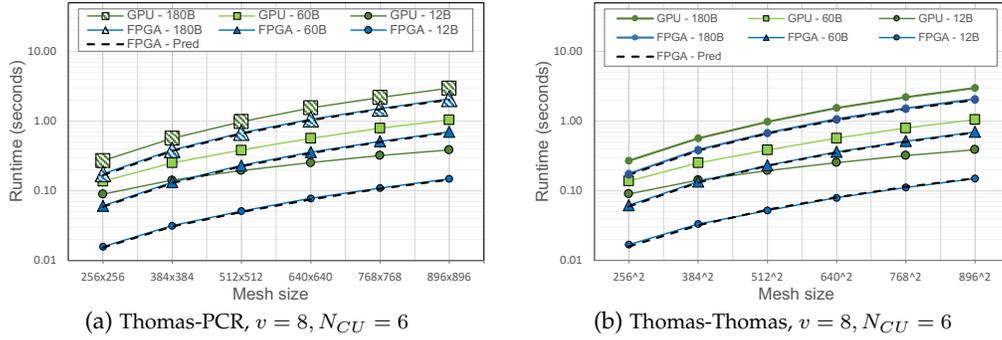


Fig. 6: 2D ADI large, FP32, 100 iter meshes

this 2D problem. Fig. 5(c) and (d) and the bottom two sub-tables in TABLE 3 detail the performance of the 3D ADI heat diffusion application in FP32 and FP64 respectively. Again we see performance trends similar to the 2D case, however we were only able to run smaller batch sizes due to HBM memory limitations for 3D meshes. On the GPU, again apart from the x-dim solve we observe good achieved bandwidth. On the FPGA the achieved bandwidth is poorer due to no unrolling of the iterative loop as done in the 2D case, where there are 3CUs each unrolled by a factor of 3. The sharing of HBM ports as described in the design of this application limits the data flow per data structure further reducing achieved bandwidth. The energy consumption of the FPGA is 3–4 $\times$  less than on the GPU.

A Thomas-Thomas based implementation for the 2D ADI-Heat application for larger mesh sizes can be modeled using (15).

$$L_{adi,2D,tiled} = n_{iter} \times (L_{rhs+x} + L_y) \quad (15)$$

$$L_{rhs+x} = 2\frac{x}{v} + 2v\frac{x}{v} + \frac{3gx}{t_1} + 4gt_1 + \frac{Bxy}{v} \quad (16)$$

$$L_y = 2y\frac{T_x}{v} + \frac{3gy}{t_2} + 4gt_2 + \frac{Bxy}{v} \quad (17)$$

In this case, RHS and x-solve can be pipelined but y-solve can't be pipe-lined together as we are computing "tiles" along the y-dim lines, huge internal memory will be required to transpose the mesh. The explicit stencil computation in RHS does not require tiling as we are not processing very large meshes. If the tile sizes for the Thomas-Thomas solvers are selected to be  $t_1$  and  $t_2$  then the reduced system sizes will be  $2t_1$  and  $2t_2$ . Equation (16) accounts for the latency for RHS with x-dimension solve where the first term is stencil latency, second term is the latency for the data path, third is for the modified Thomas solve and fourth is the reduced solve. Similarly (17) given the y-dimension solve latency. Note that here we have used  $T_x$  (this is different to  $t_1$ ) as the tile size for the x-dim data path where we buffer  $T_x \times y$  sized planes. Note also that we have selected the number of interleaved systems and interleaved reduced systems to be equal (i.e.  $g = g_r$  in relation to (8)). The final term in (16) and (17) simply gives the latency for processing a batch of B systems. Replacing the reduced system solve with the PCR algorithm is also possible where then the  $4gt_1$  and  $4gt_2$  terms in (16) and (17) will become  $\log(2t_1) \times (2t_1 + l)$  and  $\log(2t_2) \times (2t_2 + l)$ .

Fig. 6 and TABLE 4 presents the performance of 2D ADI heat diffusion application on large meshes solved us-

TABLE 4: ADI Heat Diffusion Application on large meshes: Achieved Bandwidth,  $BW$  (GB/s) and Energy,  $E$  (J)

Mesh	2D FP64 (100 iter), F1 - FPGA(Th-PCR), F2 - FPGA(Thomas-Thomas), G - GPU													
	$BW$ -60B				$E$ -60B			$BW$ -180B				$E$ -180B		
	F1	F2	Gx	Gy	F1	F2	G	F1	F2	Gx	Gy	F1	F2	G
256 <sup>2</sup>	206	203	117	238	5	5	14	217	215	186	464	13	13	35
384 <sup>2</sup>	213	209	152	323	10	10	29	220	218	204	530	29	29	74
512 <sup>2</sup>	218	217	177	400	17	17	48	222	222	210	544	51	51	128
640 <sup>2</sup>	218	217	191	450	27	27	74	221	221	211	551	80	80	217
768 <sup>2</sup>	220	219	124	471	39	39	103	223	222	211	559	114	115	308
896 <sup>2</sup>	220	219	204	503	53	53	142	222	222	214	566	156	157	418

ing Thomas-PCR and Thomas-Thomas hybrid implementations. Again we compare with the same mesh sizes solved on the GPU. Due to the RHS and `Tridslv(x-dim)` being pipelined together, the FPGA gets better HBM bandwidth utilization. The GPU also gets good bandwidth utilization where it reaches bandwidth levels similar to batched smaller meshes. The FPGA can be seen to be 2 $\times$  to 3 $\times$  more energy efficient than the GPU for the largest mesh sizes.

## 4.2 SLV

The second application we synthesize and evaluate comes from computational finance. It implements a stochastic local volatility (SLV) model, which describe asset price processes, particularly foreign exchange rates [23]. A batched GPU implementation based on a 2nd order finite-difference scheme was developed for this problem using the OPS DSL by Reguly et al. [22]. It is a 2D application implemented in FP64 representation. Its high-level algorithm is detailed in Algo. 4. The application implements a Hundsdorfer-Verwer

### Algorithm 4: 2D Heston SLV Backward

```

1: for  $i = 0, i < n_{iter}, i++$  do
2:   hv_pred0(), hv_matrices()
3:   Tridslv(x-dim)
4:   hv_pred1(), Tridslv(y-dim)
5:   hv_pred2(), Tridslv(x-dim)
6:   hv_pred3(), Tridslv(y-dim)
7: end for

```

(HV) method for time integration. The Rannacher smoothing available in the original application has been switched off in our evaluation. The `hv_pred*` and `hv_matrices` are explicit loops each using 10 point stencils, requiring a window buffer implementation [12] for data reuse. The 9 kernels in Algo. 4 were implemented as separate hardware modules pipelining the computation within the iterative loop. `hv_matrices` generates a number of 2D coefficients AX, BX, CX, AV, BV, CV and 1D coefficient EV for the

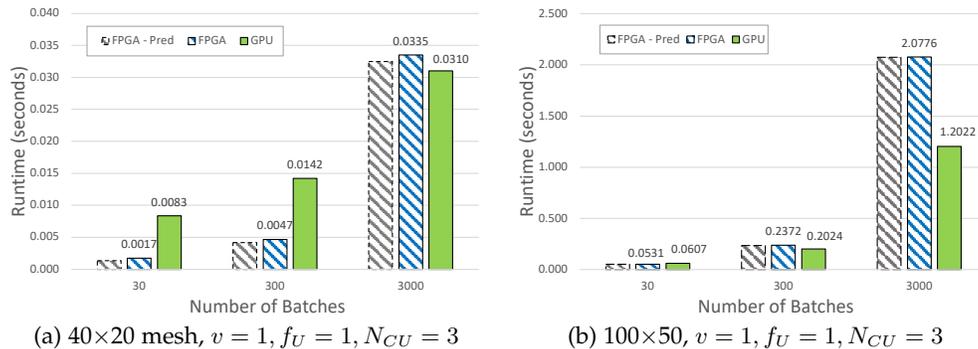


Fig. 7: SLV application performance.

Tridslvs. Coefficients AX, BX, CX then needs to be input to (consumed by) Tridslv(x-dim) kernels and coefficients AV, BV, CV and EV to Tridslv(y-dim) kernels. Therefore these coefficients are consumed at different stages of the pipeline. However other inputs to the Tridslv calls come through the computation of this multi-stage pipeline. Therefore large FIFO delay buffers are required to keep synchronization (i.e. avoid pipeline stalling). As such we opt to regenerate the above coefficients at separate stages, essentially duplicating the circuitry. This results in the generation of coefficients AX, BX, CX, for the Tridslv(x-dim), being fused to hv\_pred0() and hv\_pred2() and the generating of coefficients AV, BV, CV, EV, for the Tridslv(y-dim), being fused to hv\_pred1() and hv\_pred3(). This results in a total of 8 hardware modules, requiring significantly smaller delay buffers than if we implemented the original set of kernels. The performance model for the SLV application is given in (18):

$$L_{slv} = n_{iter} [4 \times (2x) + 2 \times (3gx) + 2 \times (3gy + 2xy) + \lceil B/N_{CU} \rceil xy] \quad (18)$$

Here  $g$  is 64 as SLV is in FP64. The first term is the combined input/output latency for the three explicit stencil computations in hv\_pred\*. The second and third terms account for the calls for Tridslv(x-dim) and Tridslv(y-dim) calls respectively, including the read/write y-lines from the buffered x-lines. The final term is the latency for processing a batch size of  $B$  2D meshes through. The number of CUs,  $N_{CU}$  for SLV on the FPGA was 3, given the considerably larger amount of DSP and memory resources required for the application, particularly due to its use of FP64 representation. The FIFO delay-buffer size calculation was aided by the Xilinx HLS tools where the exact datapath pipeline latency was estimated to obtain buffer sizes adequate for an implementation.

The motivation for batched solves of multi-dimensional tridiagonal systems primarily comes from financial computing where for example computing prices of financial options and managing of risk by hedging options leads to the need to solve Algo. 4 type applications with different sets of coefficients [22]. Additionally carrying out extensive speculative scenarios required by regulators under various market conditions to evaluate a bank's exposure means that there are large number of options in the order of thousands to hundreds of thousands to be computed every day. Such a workloads would entail large numbers of roughly identical

TABLE 5: SLV : Bandwidth,  $BW$  (GB/s) and Energy,  $E$ , (J)

Batch	40x20 mesh				
	$BW$			$E$	
	F	Gx	Gy	F	G
30	55.24	3.04	28.01	0.13	0.45
300	202.31	16.48	176.51	0.35	1.02
3000	281.06	123.84	327.65	2.51	4.75
Batch	100x50 mesh				
	$BW$			$E$	
	F	Gx	Gy	F	G
30	124.63	51.28	109.65	3.98	3.76
300	278.87	235.22	238.34	17.79	22.26
3000	318.36	421.77	429.21	155.82	216.40

PDE problems to be solved which are well suited to be batched together.

Fig. 7 and TABLE 5 details the runtime, bandwidth and energy performance of the SLV application implementation. Only two specific mesh sizes were available from the authors of the original code [22] each was batched up to 3000 batches of 2D meshes for this evaluation. The application is significantly more complex given the additional explicit stencil loops as well as the tridiagonal solvers. The runtimes here were obtained with the FPGA operating at 253.5MHz. As can be seen from the figures, the FPGA in some cases is faster than the V100 GPU, but for the largest batch sizes we attempted here, it is 8%-70% slower than the GPU. However the FPGA solution is over 30% more energy efficient for large batch solves over the GPU. The achieved bandwidth on the FPGA is approximately at the same level as the 2D ADI 64FP version. Runtime predictions from the model were also observed to be over 90% accurate for all cases.

Finally, the resource utilization for all the synthesized designs on the Alveo U280 is shown in TABLE 6. Different mesh sizes are supported without re-implementing the FPGA design. For ADI with small mesh sizes, URAM availability is the limiting factor. Thomas-PCR is marginally limited by DSP units and BRAM and did not allow for a more resource intensive design due to routing congestion. The SLV application is very much limited by the available number of DSP units on the FPGA. The implementation has 3CUs where a single SLR unit on the U280 was required for a single CU.

## 5 CONCLUSION

We presented a design space exploration for synthesizing optimized high throughput multi-dimension tridiagonal

TABLE 6: U280 resource consumption for synthesized designs

Application	%LUT	%Reg	%DSP	%BRAM	%URAM	#HBM Ports
2D ADI F32	45.9	39.0	48.2	37.1	75.0	24
2D ADI F64	42.8	30.8	35.2	61.9	85.0	18
3D ADI F32	52.7	42.9	53.2	35.4	80.0	24
3D ADI F64	32.9	24.4	27.3	17.7	75.0	24
Thomas-Thomas F32	35.8	31.1	38.0	41.7	48.8	24
Thomas-PCR F32	54.1	40.1	52.9	42.7	39.4	24
SLV	48.5	38.7	64.6	37.9	52.2	15

systems solvers on FPGAs. The main algorithms for direct solution of multiple tridiagonal systems were evaluated in light of the significant parallelization opportunities afforded by this class of solvers, particularly exploitable through the data-flow programming model on FPGAs. We developed a new tridiagonal solver library aimed at implementing high-performance computing applications on Xilinx FPGAs. Key new features of the library include data-flow techniques and optimizations for gaining high throughput with batching multiple system solves, replication of circuitry to carry out multiple solves in a “vectorized” manner and utilization of HBM memory available on modern FPGAs. The best algorithm for the FPGA with batched systems proved to be the Thomas algorithm, even with its loop carried dependencies, due to its simplicity and lower resource consumption. This somewhat subverts the conventional expectation of the more parallel PCR or spike algorithms being the best suited to get higher performance on parallel architectures. Our library, compared to the current state-of-the-art Xilinx tridiagonal library based on the PCR algorithm provided further evidence, where we see the superior performance of our Thomas based solver for larger batch sizes. However, for larger mesh sizes a hybrid Thomas-PCR or Thomas-Thomas solution was required due to the limitations of on-chip memory and demonstrated good performance overall with batched configurations.

Two representative applications (1) a heat diffusion problem based on the ADI method and (2) a stochastic local volatility (SLV) model from the financial computing domain that rely on the solution of multi-dimensional tridiagonal systems were implemented using the new library on a Xilinx Alveo U280 FPGA. As part of the design process a predictive analytic model that estimates the runtime performance of FPGA designs was also developed to assist in design space evaluations. The performance achieved by the FPGA was compared to optimized solutions of the same applications on a modern Nvidia Tesla V100 GPU, showing competitive performance, sometimes even surpassing that of the GPU. This was true for both small and larger mesh problems which enabled creating of longer pipelines keeping intermediate results on FPGA on-chip memory.

Even when runtime is inferior to the GPU, significant energy savings, over 30% for the most complex application (SLV) with large batch sizes, were observed. Considering the motivating real-world scenario for such an application from the financial computing domain, such energy savings point to a significant cost benefit in overall operation. The predictive model provides over 85% accuracy illustrating its significant utility in developing profitable FPGA designs.

The FPGA library, the 2D/3D ADI heat diffusion application and optimized GPU source code developed in this paper are available as open source software at [5]. This code repository also contains results from a Xilinx Alveo

U50 FPGA, which was also done as part of this research to investigate the performance and portability of our multi-dimensional tridiagonal solver library. The U50 results also confirms the insights and conclusions from this paper. Future work will explore the use of FPGA hardware from Intel, currently the other major FPGA device vendor, for this class of applications.

## ACKNOWLEDGMENT

Gihan Mudalige was supported by the Royal Society Industry Fellowship Scheme (INF/R1/1800 12). István Reguly was supported by National Research, Development and Innovation Fund of Hungary (PD 124905), under the PD\_17 funding scheme. We are grateful to Xilinx for their hardware and software donations and Jacques Du Toit and Tim Schmielau at NAG UK for their advice and making the SLV application available for this work.

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